HP Series SEMICON BACKEND PRECISION TOOLS CLEANING





## ATSM HIGH PRESSURE AQUEOUS JET LEADFRAME & SUBSTRATE CLEANING SYSTEM

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#### **LEADFRAME and SUBSTRATE Cleaning**



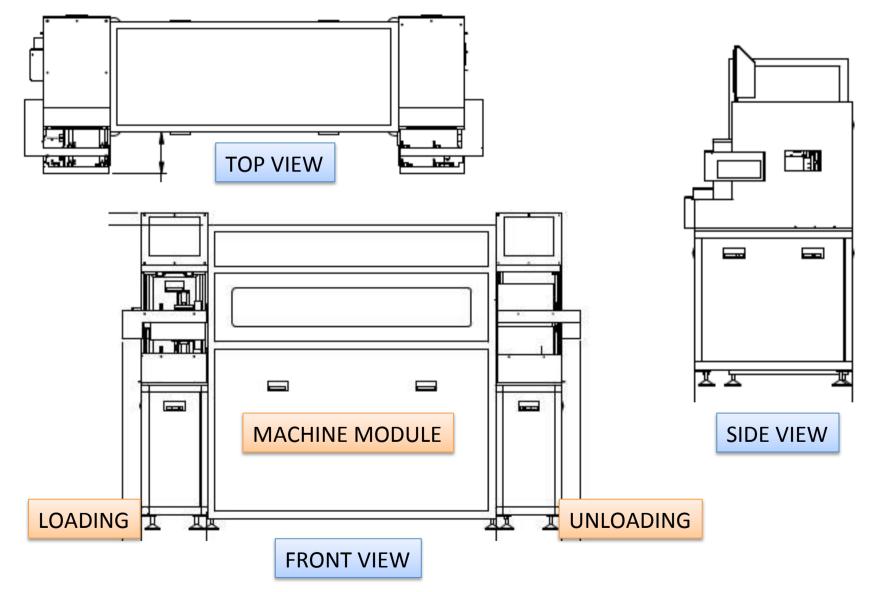
ATSM HIGH PRESSURE AQUEOUS JET LEADFRAME & SUBSTRATE CLEANING SYSTEM

AUTOTECH SOLUTION (M) SDN. BHD.

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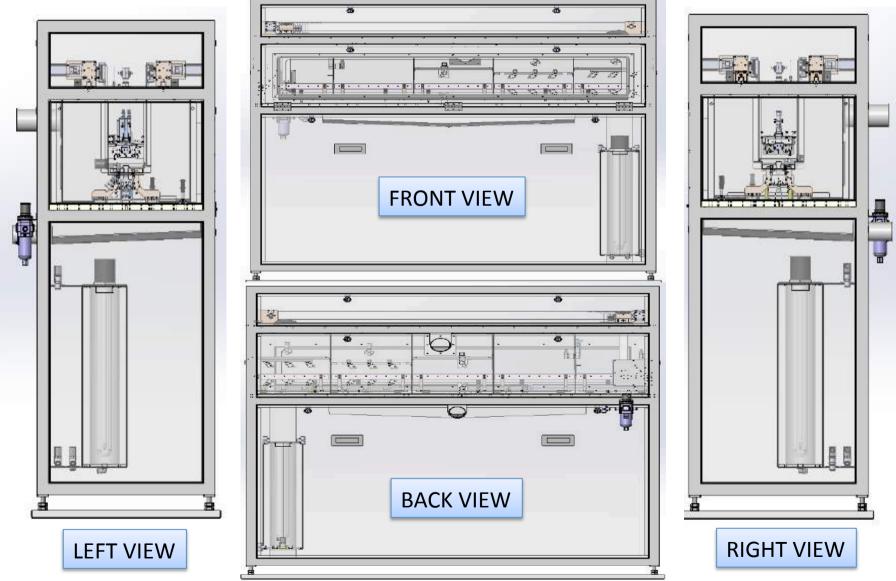
#### Advanced HIGH PRESSURE HANDLING Design (Wash - Rinse - Dry)



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#### Advanced HIGH PRESSURE HANDLING Design (Wash - Rinse - Dry)







### LOADING CDA BLOWING **BUFFER** HIGH PRESSURE HOT BLOWING TOP NOZZLE TOP BLOWER **BOTTOM BLOWER BOTTOM NOZZLE** FRONT VIEW MODULE

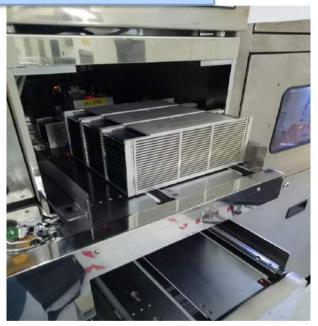




#### Advanced HIGH PRESSURE HANDLING Design (Wash - Rinse - Dry)

#### **LOADING & UNLOADING**

#### □ Magazine Loader







- Magazines with Leadframe / Substrate are manually loaded to Loader and automatically clamped and moved to programmed position.
- Loaded magazine at Unloader station is also automatically unloaded and loaded.

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#### **BUFFER**



- BUFFER is a staging station prior to high pressure cleaning a Leadframe / Substrate is readied so when either main pushers return to "Start" position (near pusher motor Home position).
- > This is enable machine to speed up processing.
- When a Leadframe / Substrate is in the Buffer station and sensor detect it's presence and pusher is at start position then main pusher starts to move or push the Leadframe / Substrate in.

Advanced HIGH PRESSURE HANDLING Design (Wash - Rinse - Dry)



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#### **HIGH PRESSURE WATER JET SPRAY**





Motor Pump 300 Bar max Water Flow: 25LPM max 20HP

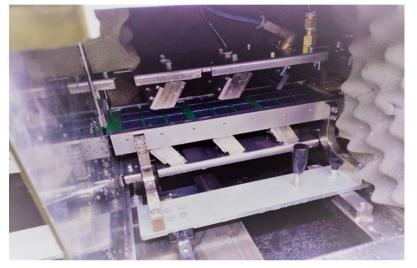
- This station the Leadframe / Substrate is cleaned by High Pressure Water Jet coming from Motor Pump.
- Leadframe / Substrate is being pushed along the tract by a motor driven main pusher.
- Leadframe / Substrate top and bottom surface are being clean by Water Jet Nozzle to remove the particles.

Advanced HIGH PRESSURE HANDLING Design (Wash - Rinse - Dry)



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#### **CDA BLOWER**



- Main pusher pushes past High Pressure station to CDA Blower station which is CDA blowing.
- Air Nozzles top and bottom to blows away water droplets from Leadfarme / Substrate.
- > This is in coming CDA.

### **JET** HP Series SEMICON BACKEND PRECISION TOOLS CLEANING Advanced HIGH PRESSURE HANDLING Design (Wash - Rinse - Dry)



#### **HOT AIR BLOWER**









- > Last Station is a Hot Air Blower to dry Leadframe / Substrate by using Hot Air Recirculation design with stainless steel Finned Heater heating system, made in Germany High Temperature Blower.
- > We are using the nozzles to dry the Leadframe / Substrate.
- The temperature is set to about 100 to 120 deg C, it will be fully dry the  $\geq$ Leadframe / Substrate.